# 1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 3 A
- Reverse voltage: V<sub>R</sub> ≤ 60 V
- Low forward voltage
- · High power capability due to clip-bond technology
- · Small and flat lead SMD plastic package
- Suitable for both reflow and wave soldering
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- · Low voltage rectification
- · High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)
- · Reverse polarity protection
- Low power consumption applications

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>amb</sub> ≤ 50 °C	[1]	-	-	3	Α
		$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> ≤ 135 °C		-	-	3	А
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	-	60	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 3 A; T <sub>j</sub> = 25 °C		-	460	530	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 60 V; T <sub>j</sub> = 25 °C		-	80	200	μΑ

[1] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.



# 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		K <del>_[C </del> -A
2	А	anode	1 2 CFP5 (SOD128)	sym001

<sup>[1]</sup> The marking bar indicates the cathode.

## 6. Ordering information

#### **Table 3. Ordering information**

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Type number	Package						
	Name	Description	Version				
PMEG6030EP-Q		plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128				

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMEG6030EP-Q	AB

2/13

## 8. Limiting values

#### **Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	60	V
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; $T_{amb} \le$ 50 °C	[1]	-	3	А
		$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> ≤ 135 °C		-	3	А
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; square wave; $T_{j(init)}$ = 25 °C		-	50	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[2]	-	625	mW
			[3]	-	1.05	W
			[1]	-	2.1	W
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

- [1] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

#### 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from	in free air	[1] [2]	-	-	200	K/W
junction to ambient	junction to ambient		[3] [2]	-	-	120	K/W
			[4] [2]	-	-	60	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[5]	-	-	12	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [5] Soldering point of cathode tab.

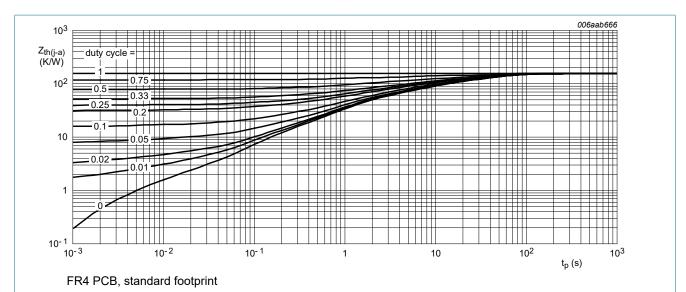


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

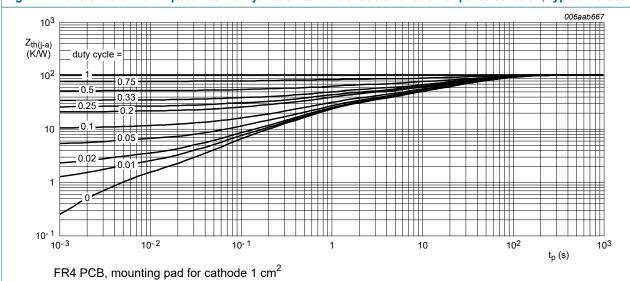


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

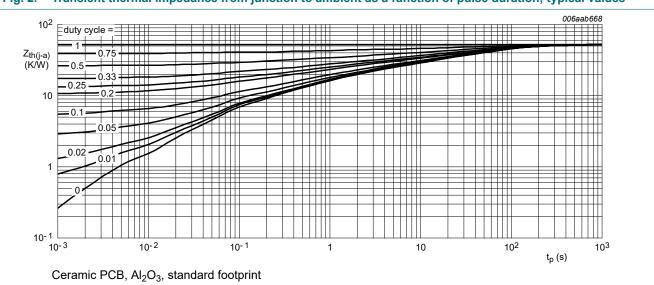


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 0.1 A; T <sub>j</sub> = 25 °C	-	290	330	mV
		I <sub>F</sub> = 0.5 A; T <sub>j</sub> = 25 °C	-	340	400	mV
		I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C	-	380	440	mV
		I <sub>F</sub> = 1.5 A; T <sub>j</sub> = 25 °C	-	400	470	mV
		I <sub>F</sub> = 2 A; T <sub>j</sub> = 25 °C	-	430	500	mV
		I <sub>F</sub> = 3 A; T <sub>j</sub> = 25 °C	-	460	530	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 5 V; T <sub>j</sub> = 25 °C	-	4	-	μA
		V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C	-	5	-	μA
		V <sub>R</sub> = 60 V; T <sub>j</sub> = 25 °C	-	80	200	μA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	360	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	120	-	pF

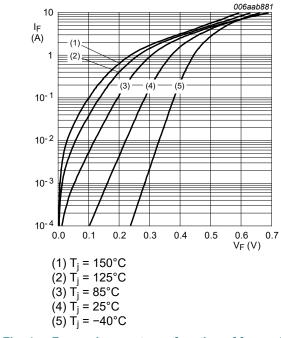


Fig. 4. Forward current as a function of forward voltage; typical values

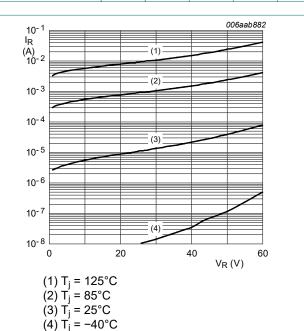


Fig. 5. Reverse current as a function of reverse voltage; typical values

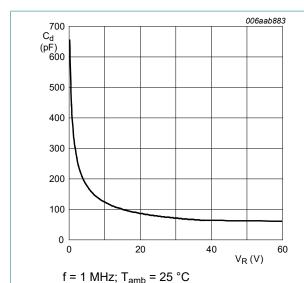
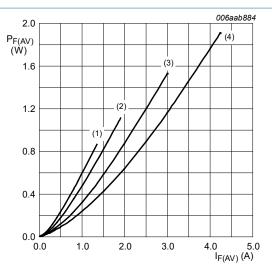
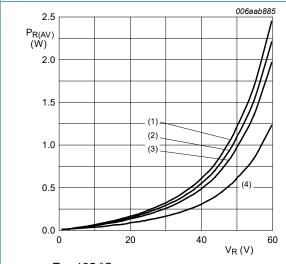


Fig. 6. Diode capacitance as a function of reverse voltage; typical values



 $T_j = 150 \,^{\circ}\text{C}$ (1)  $\delta = 0.1$ (2)  $\delta = 0.2$ (3)  $\delta = 0.5$ (4)  $\delta = 1$ 

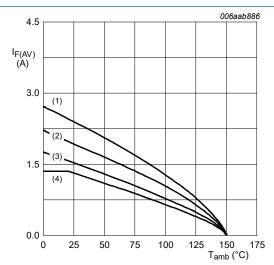
Fig. 7. Average forward power dissipation as a function of average forward current; typical values



 $T_j = 125 \,^{\circ}\text{C}$ (1)  $\delta = 1$ (2)  $\delta = 0.9$ (3)  $\delta = 0.8$ 

 $(4) \delta = 0.5$ 

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint T<sub>i</sub> = 150 °C

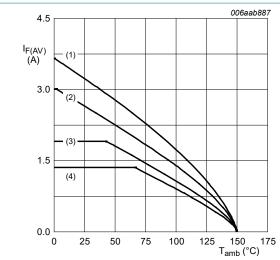
(1)  $\delta = 1$ ; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

 $T_i = 150 \, ^{\circ}C$ 

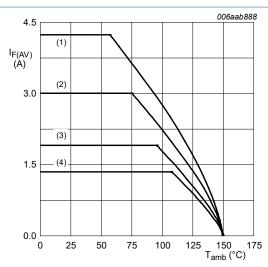
 $(1) \delta = 1; DC$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

T<sub>i</sub> = 150 °C

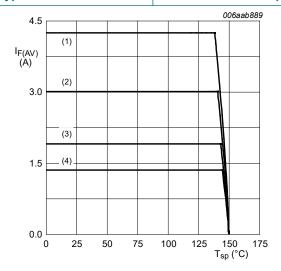
(1) δ = 1; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



T<sub>i</sub> = 150 °C

 $(1) \delta = 1; DC$ 

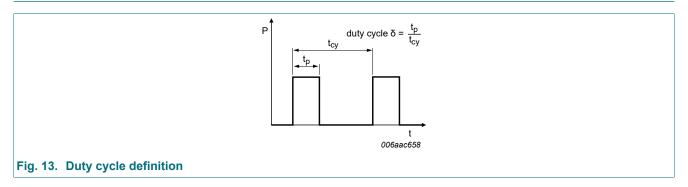
(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 12. Average forward current as a function of solder point temperature; typical values

## 11. Test information

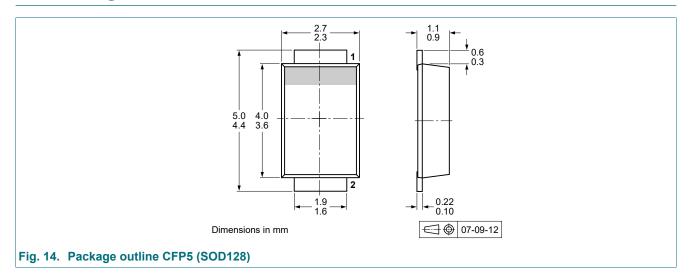


The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

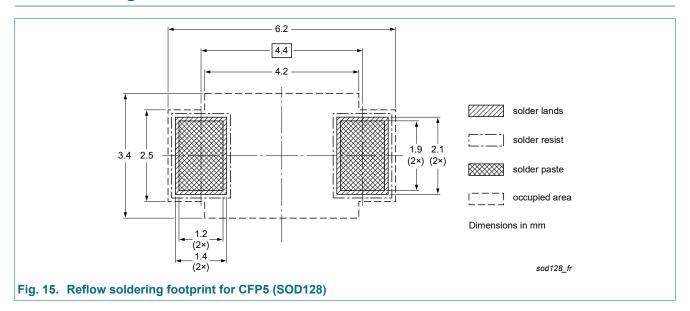
#### **Quality information**

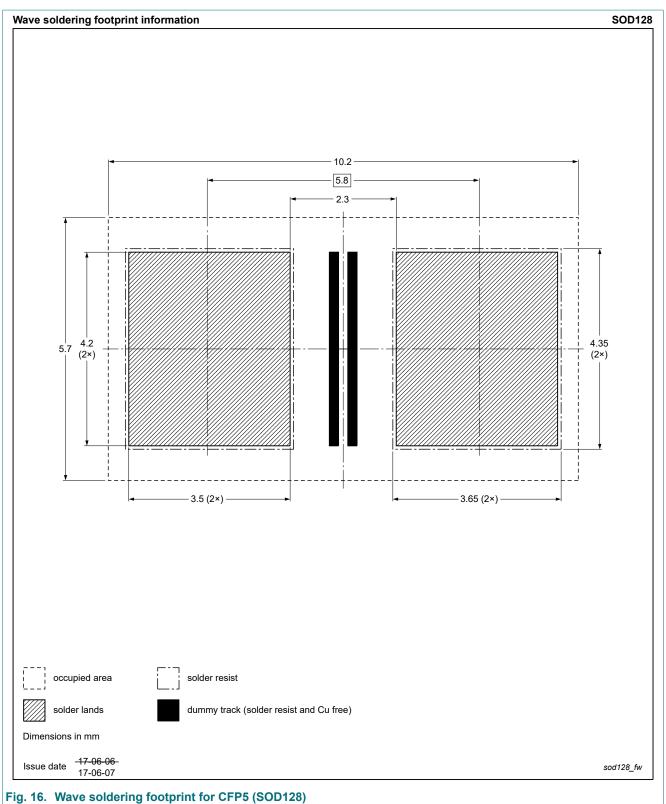
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

# 12. Package outline



## 13. Soldering





# 14. Revision history

#### **Table 8. Revision history**

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG6030EP-Q v.1	20210719	Product data sheet	-	-

11 / 13

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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## **Contents**

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Marking	2
8.	Limiting values	3
9.	Thermal characteristics	3
10.	Characteristics	5
11.	Test information	8
12.	Package outline	9
13.	Soldering	9
	Revision history	
	Legal information	

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